



## **Features**

- Capacities up to 8GB
- Small form factor for embedded applications
- IDE interface
- 2 million write/erase cycles
- Sustained throughput up to 10MB/s
- Low power consumption
- Engineered for harsh environments
- Industrial operating temperature ranges
- Automatic bad block management
- Configurable vendor ID/Product ID (VID/PID)
- MTBF: Over 4 million hours
- 5-year warranty
- RoHS compliant

# **IDE** FlashDisk Module

**Industrial Grade Solid State Storage** 

SimpleTech Flash Disk Modules provide non-volatile, solid-state storage in a compact design perfectly suited for embedded applications. Built-in wear leveling algorithms, on-the-fly ECC, and over two million write/erase cycles give you superior data integrity and reliability. Available with industry standard IDE interface; Application software compatibility is ensured as no proprietary software drivers are required.

At the heart of all SimpleTech industrial grade solid state storage products is a proprietary controller that incorporates an advanced dynamic wear leveling algorithm in combination with 5 bit EDC / 4 bit ECC delivering exceptional endurance and reliability.

With no moving parts, SimpleTech flash disk modules are inherently more rugged and reliable than rotating hard drives. New applications for flash disk modules are rapidly emerging due to the low cost per megabyte. Most applications running embedded operating systems such as VxWorks, Windows, XP/embedded, and Linux do not have large data storage requirements, and a cost savings can be immediately realized.

SimpleTech also offers value-added services like customized form factors, testing, custom firmware, software imaging, controlled bill of materials, customer-specific labeling and serialization.

# **OEM Storage Solutions from STEC**

# Product Key

Part #:	SLFDM(xx)(zzz)-(xxx)(M/G)M1U(I)
	Pin
XX =	
XXX =	
M/G =	Megabyte/Gigabyte
=	Industrial Temperature
U =	RoHS Compliant
zzz = IDE Connector Orientation:	
V (Vertical), H (Horizontal),	
LPV (Low profile vertical), LPH (Low profile horizontal)	
ex. SLFDM40H-512MM1U(I) =	
512MB 40Pin Flash Disk Module (Horizontal)	
SLFDM44LPV-8GM1U(I) =	
8GB 44Pin Flash Disk Module (Low profile vertical)	

### Specifications

#### **INTERFACE** TRUE IDE (40/44 pin) CAPACITY 128MB to 8GB PERFORMANCE Data Transfer Rate Sustained Read/Write Up to 10MB/sec Burst Read/Write Up to 16.7MB/sec **POWER CONSUMPTION Typical Power Consumption** 2mA Sleep Current 60mA - 70mA Read Current Write Current 65mA - 75mA **ENVIRONMENTAL Operating Temperature** Commercial 32°F to 158°F (0°C to 70°C) -40°F to 185°F (-40°C to 85°C) Industrial Storage Temperature -40°F to 185°F (-40°C to 85°C) **Operating Viberation** 15 G, 10-2000 Hz @ 147 meter/sec **Operating Shock** 1000 G, 4903.3 meter/sec RELIABILITY Data Write/Erase Endurance 2 million cycle min. Data Reliability 1 in 10<sup>14</sup> bits read Data Retention 10 years **PHYSICAL** 2.00 to 2.19 in. (50.80 to 55.63 mm) Length Width 0.88 to 1.58 in. (22.35 to 40.13 mm) Thickness 0.44 to 0.64 in. (11.18 to 16.26 mm) Applications Instrumentation • Data Recorders Medical Equipment Avionics Systems Machine Automation Electronic Kiosks • Telecommunications Networking Equipment





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